$V_{RRM} = 4500 V$

 $I_{FAVM} = 650 A$

 $I_{FSM} = 16 \text{ kA}$

 $V_{F0} = 1.4 V$

 $r_F = 1 m\Omega$

 $V_{DClink} = 2800 V$

Fast Recovery Diode

5SDF 07F4501

Doc. No. 5SYA1107-03 Sep. 01

- · Patented free-floating silicon technology
- · Low on-state and switching losses
- Optimized for use as freewheeling diode in GTO converters with high DC link voltages
- Standard press-pack housing, hermetically cold-welded
- · Cosmic radiation withstand rating

Blocking

V_{RRM}	Repetitive peak reverse voltage	4500 V	Half sine wave, t_P = 10 ms, f = 50 Hz		
I _{RRM}	Repetitive peak reverse current	≤ 50 mA	$V_R = V_{RRM,} T_j = 125^{\circ}C$		
V_{DClink}	Permanent DC voltage for 100 FIT failure rate	2800 V	100% Duty	Ambient cosmic radiation at sea level in open air.	
V_{DClink}	Permanent DC voltage for 100 FIT failure rate	V	5% Duty		

Mechanical data (see Fig. 12)

E Mounting force	Mounting force	min.		20 kN
F _m		max.		24 kN
а	Acceleration: Device unclamped Device clamped			50 m/s ² 200 m/s ²
m	Weight			0.46 kg
Ds	Surface creepage distance		≥	33 mm
D _a	Air strike distance		≥	20 mm



On-state (see Fig. 2, 3)

I _{FAVM}	Max. average on-state current	650 A	Half sine wave, $T_c = 85^{\circ}C$		
I _{FRMS}	Max. RMS on-state current	1000 A			
I _{FSM}	Max. peak non-repetitive	16 kA	tp = 10 ms Before surge:		
	surge current	44 kA	tp = 1 ms $T_c = T_j = 125^{\circ}C$		
∫l ² dt	Max. surge current integral	1.28·10 ⁶ A ² s	tp = 10 ms After surge:		
		0.8·10 ⁶ A ² s	tp = 1 ms $V_R \approx 0 \text{ V}$		
V _F	Forward voltage drop	≤ 2.7 V	I _F = 1250 A		
V _{F0}	Threshold voltage	1.4 V	Approximation for $T_j = 125^{\circ}C$		
r _F	Slope resistance	1 mΩ	I _F = 4002000 A		

Turn-on (see Fig. 4, 5)

V _{fr}	Peak forward recovery voltage	≤	74 V	di/dt = 500 A/µs, T _j = 125°C
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Turn-off (see Fig. 6 to 11)

Irr	Reverse recovery current	≤	600 A	$di/dt = 300 \text{ A/}\mu\text{s}, I_F = 700 \text{ A},$	
Q _{rr}	Reverse recovery charge	≤	1900 µC	$T_j = 125^{\circ}C, V_{RM} = 4500 V,$	
E _{rr}	Turn-off energy	≤	1 J	$C_S = 3\mu F$ (GTO snubber circuit)	

Thermal (see Fig. 1)

T _j	Operating junction temperature range	-40125°C		
T _{stg}	Storage temperature range	-40125°C		
R _{thJC}	Thermal resistance junction to case	≤ 40 K/kW	Anode side cooled	
		≤ 40 K/kW	Cathode side cooled	F _m =
		≤ 20 K/kW	Double side cooled	20 24 kN
R _{thCH}	Thermal resistance case to heatsink	≤ 10 K/kW	Single side cooled	
		≤ 5 K/kW	Double side cooled	

Analytical function for transient thermal impedance.

$$Z_{\text{thJC}}(t) = \sum_{i=1}^{n} R_{i}(1 - e^{-t/\tau_{i}})$$

i	1	2	3	4			
R _i (K/kW) 11.83 4.26 1.63 2.28							
τ _i (s) 0.432 0.071 0.01 0.0054							
F _m = 20 24 kN Double side cooled							

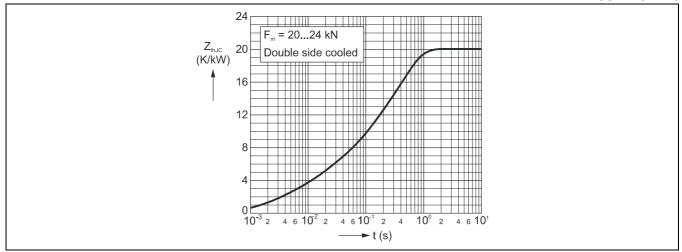


Fig. 1 Transient thermal impedance (junction-to-case) vs. time in analytical and graphical form (max. values).

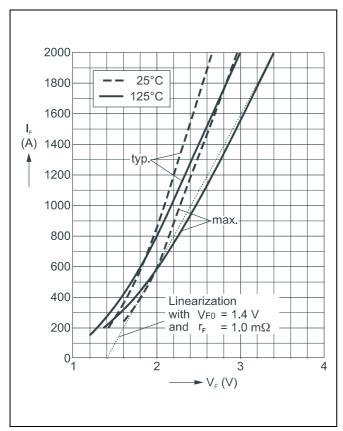


Fig. 2 Forward current vs. forward voltage (typ. and max. values) and linear approximation of max. curve at 125°C.

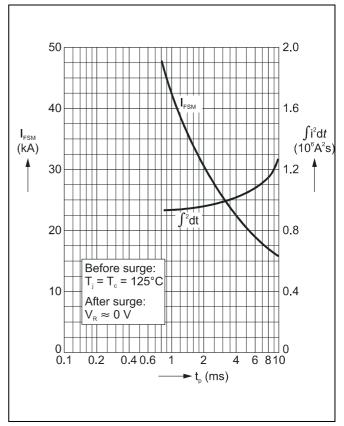
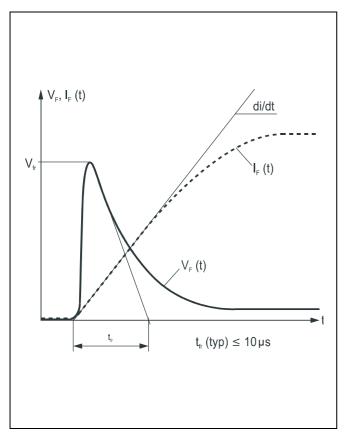


Fig. 3 Surge current and fusing integral vs. pulse width (max. values) for non-repetitive, half-sinusoidal surge current pulses.



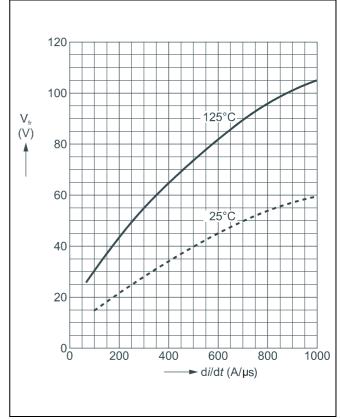


Fig. 4 Typical forward voltage waveform when the diode is turned on with a high di/dt.

Fig. 5 Forward recovery voltage vs. turn-on di/dt (max. values).

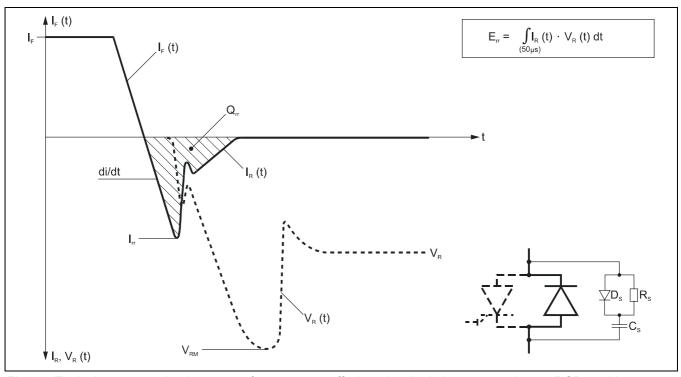


Fig. 6 Typical current and voltage waveforms at turn-off when the diode is connected to an RCD snubber, as often used in GTO circuits.

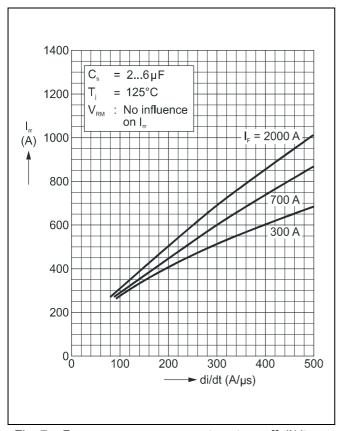


Fig. 7 Reverse recovery current vs. turn off di/dt (max. values).

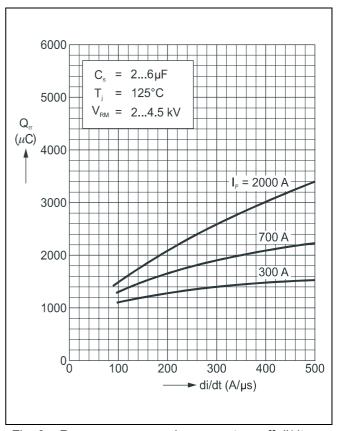


Fig. 8 Reverse recovery charge vs. turn off di/dt (max. values).

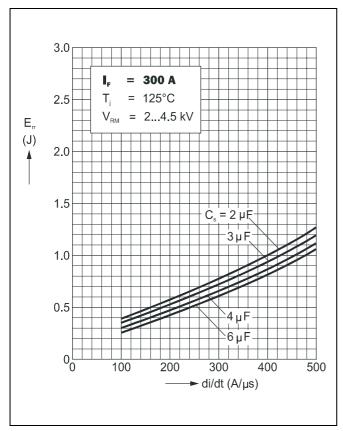


Fig. 9 Turn-off energy vs. turn-off di/dt for $I_F = 300$ A (max. values).

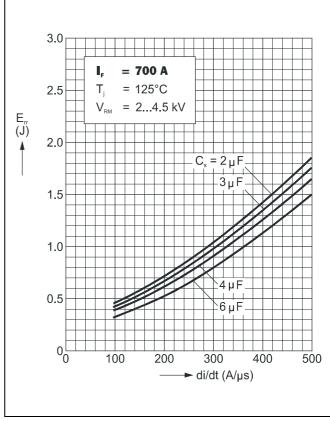


Fig. 10 Turn-off energy vs. turn-off di/dt for $I_F = 700$ A (max. values).

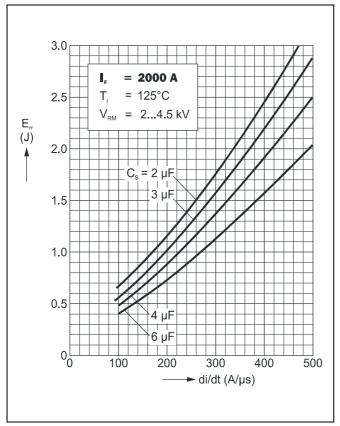


Fig. 11 Turn-off energy vs. turn-off di/dt for $I_F = 2000$ A (max. values).

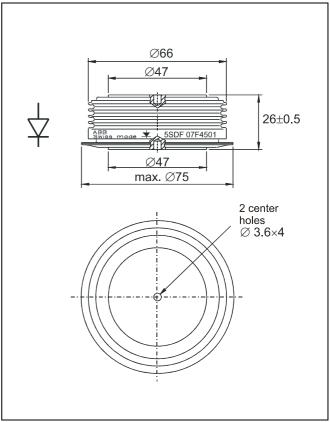


Fig. 12 Outline drawing. All dimensions are in millimeters and represent nominal values unless stated otherwise.

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